74LVC16245A; 74LVCH16245A

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Rev. 12 — 13 February 2012

Product data sheet

1. General description

The 74LVC16245A; 74LVCH16245A are 16-bit transceivers featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features two output enable (nOE) inputs for easy cascading and two send/receive (nDIR) inputs for direction control. nOE controls the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH16245A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- All data inputs have bus hold (74LVCH16245A only)
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

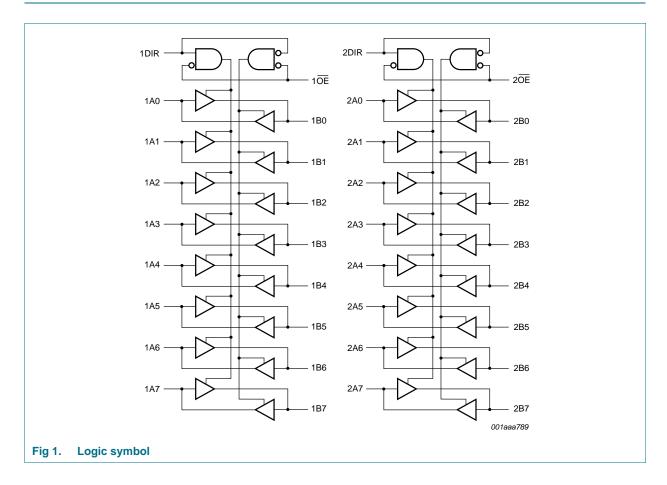


3. Ordering information

Table 1. Ordering information

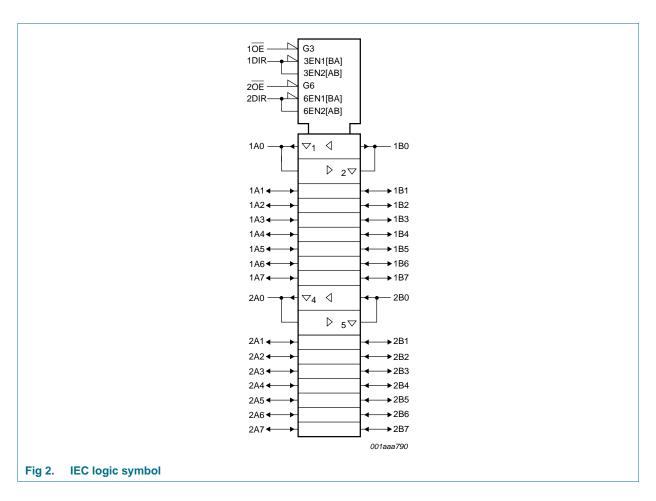
Type number	Temperature range	Package	Package						
		Name	Description	Version					
74LVC16245ADL	-40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads;	SOT370-1					
74LVCH16245ADL			body width 7.5 mm						
74LVC16245ADGG	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package;	SOT362-1					
74LVCH16245ADGG			48 leads; body width 6.1 mm						
74LVC16245AEV	$-40~^{\circ}\text{C}$ to +125 $^{\circ}\text{C}$	VFBGA56	plastic very thin fine-pitch ball grid array package;	SOT702-1					
74LVCH16245AEV			56 balls; body $4.5 \times 7 \times 0.65$ mm						
74LVC16245ABX	–40 °C to +125 °C	HXQFN60	plastic compatible thermal enhanced extremely	SOT1134-2					
74LVCH16245ABX	_		thin quad flat package; no leads; 60 terminals; body $4 \times 6 \times 0.5$ mm						

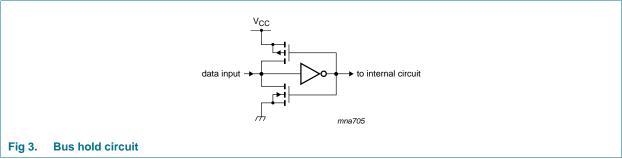
4. Functional diagram



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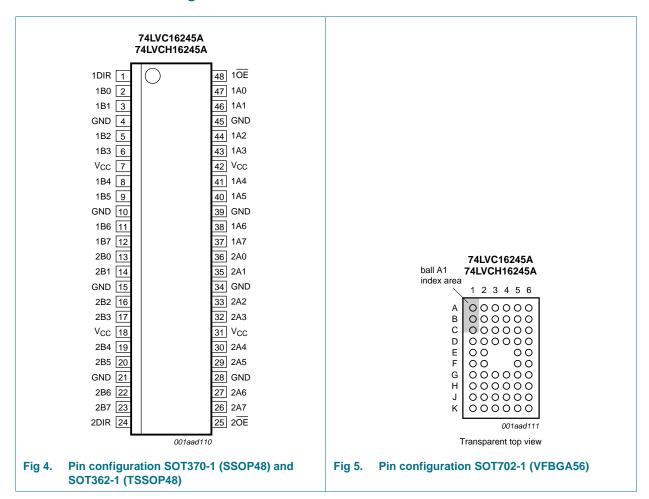
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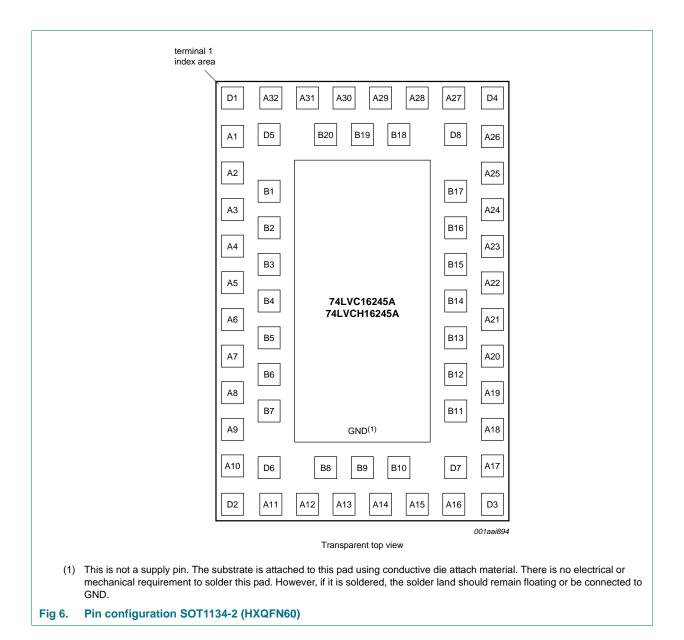


5. Pinning information

5.1 Pinning



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5.2 Pin description

Table 2. Pin description

Symbol	Pin		Description	
	SOT370-1 and SOT362-1	SOT702-1	SOT1134-2	
1DIR, 2DIR	1, 24	A1, K1	A30, A13	direction control input
1B0 to 1B7	2, 3, 5, 6, 8, 9, 11, 12	B2, B1, C2, C1, D2, D1, E2, E1	B20, A31, D5, D1, A2, B2, B3, A5	data input/output
2B0 to 2B7	13, 14, 16, 17, 19, 20, 22, 23	F1, F2, G1, G2, H1, H2, J1, J2	A6, B5, B6, A9, D2, D6, A12, B8	data input/output
GND	4, 10, 15, 21, 28, 34, 39, 45	B3, B4, D3, D4, G3, G4, J3, J4	A32, A3, A8, A11, A16, A19, A24, A27	ground (0 V)
V _{CC}	7, 18, 31, 42	C3, C4, H3, H4	A1, A10, A17, A26	supply voltage
10E, 20E	48, 25	A6, K6	A29, A14	output enable input (active LOW)
1A0 to 1A7	47, 46, 44, 43, 41, 40, 38, 37	B5, B6, C5, C6, D5, D6, E5, E6	B18, A28, D8, D4, A25, B16, B15, A22	data input/output
2A0 to 2A7	36, 35, 33, 32, 30, 29, 27, 26	F6, F5, G6, G5, H6, H5, J6, J5	A21, B13, B12, A18, D3, D7, A15, B10	data input/output
n.c.	-	A2, A3, A4, A5, K2, K3, K4, K5	A4, A7, A20, A23, B1, B4, B7, B9, B11, B14, B17, B19	not connected

6. Functional description

Table 3. Function table[1]

Inputs		Outputs		
nOE	nDIR	nAn	nBn	
L	L	nAn = nBn	inputs	
L	Н	inputs	nBn = nAn	
Н	X	Z	Z	

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
V_{I}	input voltage		[<u>1</u>] -0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
Vo	output voltage	output HIGH or LOW	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[2]</u> –0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		–65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C};$			
		(T)SSOP48 package	[3]	500	mW
		VFBGA56 package	[4] _	1000	mW
		HXQFN60 package	<u>[4]</u> -	1000	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Parameter	Conditions	Min	Тур	Max	Unit
supply voltage		1.65	-	3.6	V
	functional	1.2	-	3.6	V
input voltage		0	-	5.5	V
output voltage	output HIGH or LOW	0	-	V_{CC}	V
	output 3-state	0		V	
ambient temperature	in free air	-40	-	+125	°C
input transition rise and fall rate	$V_{CC} = 1.2 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V
	input voltage output voltage ambient temperature	$\begin{tabular}{ll} supply voltage & & & \\ \hline functional & & \\ \hline input voltage & & output HIGH or LOW \\ \hline output 3-state & \\ \hline ambient temperature & in free air \\ \hline input transition rise and fall rate & V_{CC} = 1.2 V to 2.7 V \\ \hline \end{tabular}$	$\begin{array}{c} \text{supply voltage} & 1.65 \\ \hline \text{functional} & 1.2 \\ \hline \text{input voltage} & 0 \\ \hline \text{output voltage} & \text{output HIGH or LOW} & 0 \\ \hline \text{output 3-state} & 0 \\ \hline \text{ambient temperature} & \text{in free air} & -40 \\ \hline \text{input transition rise and fall rate} & V_{\text{CC}} = 1.2 \text{ V to 2.7 V} & 0 \\ \hline \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

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^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] Above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.

^[4] Above 70 °C the value of Ptot derates linearly with 1.8 mW/K.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °	°C to +8	5 ℃	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V_{IH}	HIGH-level input	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level input	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.2	-	-	$V_{CC}-0.3$	-	V
		$I_O = -4 \text{ mA}$; $V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_O = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_O = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_O = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL} LO	LOW-level output	$V_I = V_{IH}$ or V_{IL}						
	voltage	I_O = 100 μ A; V_{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I _I	input leakage current[2]	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 3.6 \text{ V}$	-	±0.1	±5	-	±20	μА
l _{OZ}	OFF-state output current[2][3]	$V_I = V_{IH}$ or V_{IL} ; $V_O = 5.5$ V or GND; $V_{CC} = 3.6$ V	-	±0.1	±5	-	±20	μΑ
I _{OFF}	power-off leakage current	V_I or $V_O = 5.5 \text{ V}$; $V_{CC} = 0.0 \text{ V}$	-	±0.1	±10	-	±20	μА
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6$ V	-	0.1	20	-	80	μА
ΔI_{CC}	additional supply current	per input pin; $V_I = V_{CC} - 0.6 \text{ V}$; $I_O = 0 \text{ A}$; $V_{CC} = 2.7 \text{ V}$ to 3.6 V	-	5	500	-	5000	μΑ
C _I	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_I = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF
C _{I/O}	input/output capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	10	-	-	-	pF

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Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	S °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
I_{BHL}	bus hold LOW	$V_{CC} = 1.65; V_I = 0.58 V$	10	-	-	10	-	μΑ
	current [4][5]	$V_{CC} = 2.3; V_I = 0.7 V$	30	-	-	25	-	μΑ
		$V_{CC} = 3.0; V_I = 0.8 V$	75	-	-	60	-	μΑ
I _{BHH}	l _{BHH} bus hold HIGH current [4][5]	$V_{CC} = 1.65; V_I = 1.07 V$	-10	-	-	-10	-	μΑ
Cl		$V_{CC} = 2.3; V_I = 1.7 V$	-30	-	-	-25	-	μΑ
		$V_{CC} = 3.0$; $V_I = 2.0 \text{ V}$	-75	-	-	-60	-	μΑ
I _{BHLO}	bus hold LOW	V _{CC} = 1.95 V	200	-	-	200	-	μΑ
	overdrive current [4][6]	V _{CC} = 2.7 V	300	-	-	300	-	μΑ
	<u>[-5][-5]</u>	V _{CC} = 3.6 V	500	-	-	500	-	μΑ
I _{BHHO}	bus hold HIGH	V _{CC} = 1.95 V	-200	-	-	-200	-	μΑ
	overdrive current [4][6]	V _{CC} = 2.7 V	-300	-	-	-300	-	μΑ
	<u>[4][0]</u>	V _{CC} = 3.6 V	-500	-	-	-500	-	μΑ

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	+125 °C	Unit
			Min	Typ[2]	Max	Min	Max	
t_{pd}	propagation	nAn to nBn; nBn to nAn; see Figure 7						
	delay	V _{CC} = 1.2 V	-	13.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.5	5.2	12.2	1.5	13.8	ns
		V _{CC} = 2.3 V to 2.7 V	1.0	2.8	6.0	1.0	6.7	ns
		V _{CC} = 2.7 V	1.0	2.7	4.7	1.0	6.0	ns
		V _{CC} = 3.0 V to 3.6 V	1.0	2.4	4.5	1.0	6.0	ns
t _{en}	enable time	nOE to nAn, nBn; see Figure 8						
		V _{CC} = 1.2 V	-	15.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.5	5.9	15.0	1.5	16.9	ns
		V _{CC} = 2.3 V to 2.7 V	1.0	3.3	7.9	1.0	8.8	ns
		V _{CC} = 2.7 V	1.5	3.5	6.7	1.5	8.5	ns
		V _{CC} = 3.0 V to 3.6 V	1.0	2.7	5.5	1.0	7.0	ns

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^[2] The bus hold circuit is switched off when $V_I > V_{CC}$ allowing 5.5 V on the input terminal.

^[3] For I/O ports the parameter I_{OZ} includes the input leakage current.

^[4] Valid for data inputs of bus hold parts only (74LVCH16245A). Note that control inputs do not have a bus hold circuit.

^[5] The specified sustaining current at the data input holds the input below the specified V_I level.

^[6] The specified overdrive current at the data input forces the data input to the opposite input state.

Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions		-40 °C to +85 °C			-40 °C to +125 °C		Unit
				Min	Typ[2]	Max	Min	Max	
t_{dis}	disable time	nOE to nAn, nBn; see Figure 8	<u>[1]</u>						
		V _{CC} = 1.2 V		-	11.0	-	-	-	ns
	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	4.9	13.1	1.0	14.7	ns	
	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.7	7.1	0.5	7.9	ns	
		$V_{CC} = 2.7 \text{ V}$		1.5	3.4	6.6	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.3	5.6	1.5	7.0	ns
C_{PD}	power	per input; $V_I = GND$ to V_{CC}	[3]						
	dissipation capacitance	V _{CC} = 1.65 V to 1.95 V		-	11.5	-	-	-	pF
	capacitance	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	15.2	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	18.5	-	-	-	pF

- [1] t_{pd} is the same as t_{PLH} and t_{PHL}.
 - t_{en} is the same as t_{PZL} and t_{PZH} .
 - t_{dis} is the same as t_{PLZ} and t_{PHZ}.
- [2] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.2$ V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
 - $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

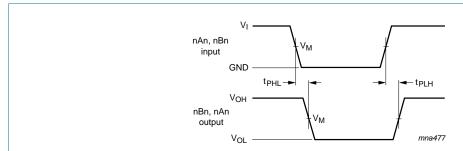
 C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs.

11. Waveforms



Measurement points are given in Table 8.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 7. The input (nAn, nBn) to output (nBn, nAn) propagation delays

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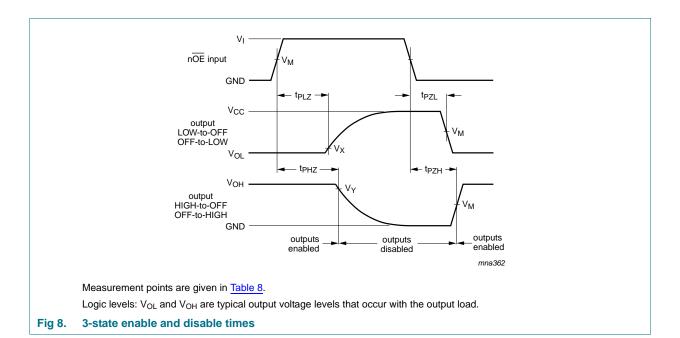
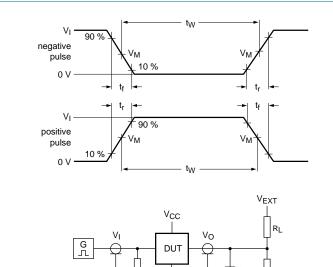


Table 8. Measurement points

Supply voltage	V _M	Input	Input						
V _{CC}		VI	$t_r = t_f$	V _X	V _Y				
1.2 V	$0.5 \times V_{\text{CC}}$	V _{CC}	\leq 2.5 ns	V _{OL} + 0.15 V	$V_{OH}-0.15\ V$				
1.65 V to 1.95 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2.5 ns	V _{OL} + 0.15 V	$V_{OH}-0.15\ V$				
2.3 V to 2.7 V	$0.5 \times V_{\text{CC}}$	V _{CC}	≤ 2.5 ns	V _{OL} + 0.15 V	$V_{OH}-0.15\ V$				
2.7 V	1.5 V	2.7 V	≤ 2.5 ns	V _{OL} + 0.3 V	$V_{OH}-0.3\ V$				
3.0 V to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns	$V_{OL} + 0.3 V$	$V_{OH} - 0.3 V$				

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Test data is given in Table 9.

Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

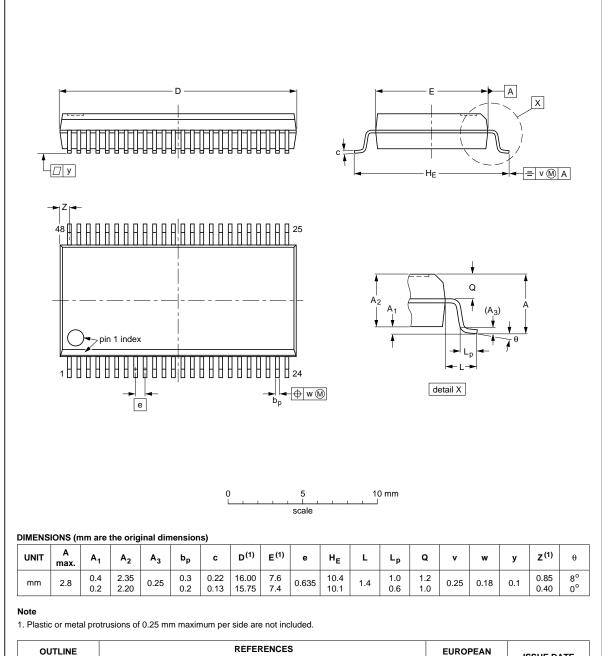
Table 9. Test data

Supply voltage	Input	Input		Load		V _{EXT}		
	V _I	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t_{PLZ}, t_{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 k Ω	open	$2\times V_{CC}$	GND	
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND	

12. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT370-1		MO-118				99-12-27 03-02-19	

Fig 10. Package outline SOT370-1 (SSOP48)

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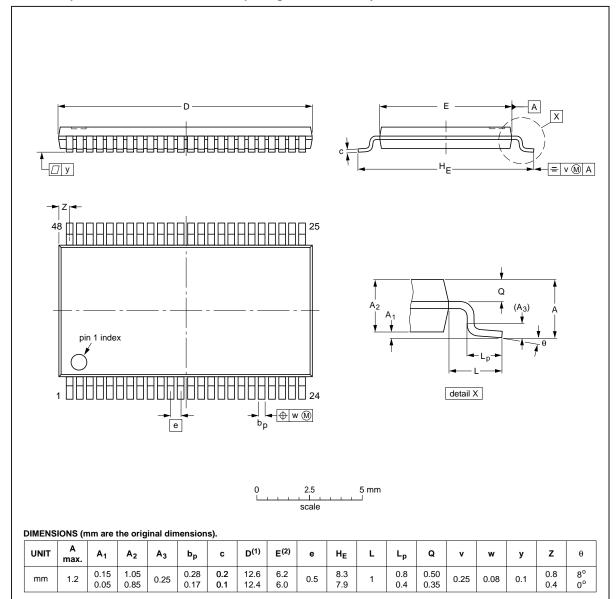
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TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT362-1		MO-153				-99-12-27 03-02-19
		•	•	•	•	

Fig 11. Package outline SOT362-1 (TSSOP48)

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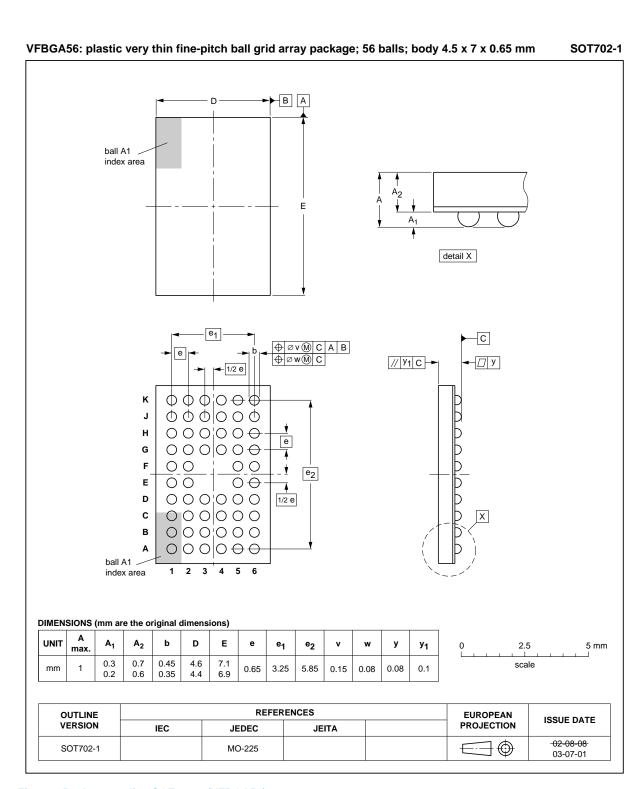


Fig 12. Package outline SOT702-1 (VFBGA56)

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Product data sheet

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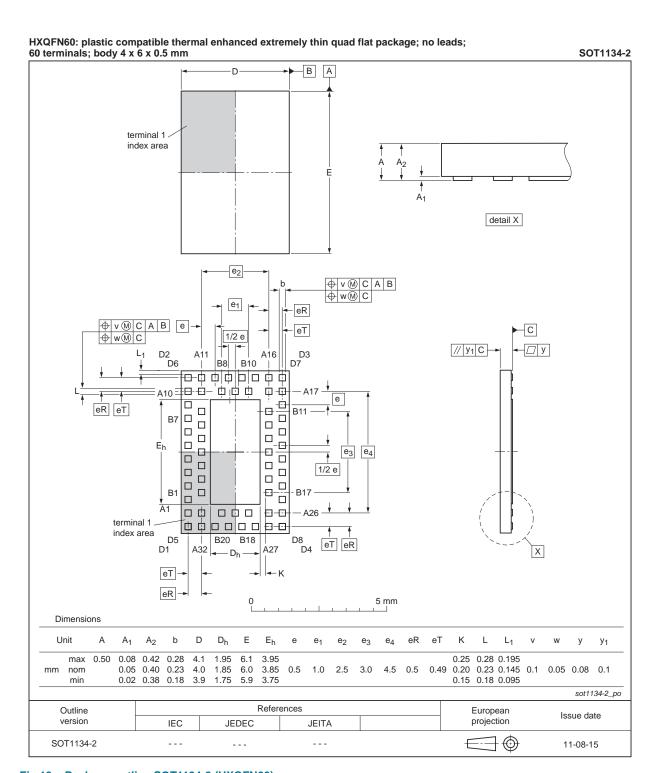


Fig 13. Package outline SOT1134-2 (HXQFN60)

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13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH16245A v.12	20120213	Product data sheet	-	74LVC_LVCH16245A v.11
Modifications:	 For type numb SOT1134-2. 	er 74LVC16245ABX and	74LVCH16245ABX	the sot code has changed to
74LVC_LVCH16245A v.11	20111208	Product data sheet	-	74LVC_LVCH16245A v.10
Modifications:	• Table 4, Table	<u>5, Table 6, Table 7, and 1</u>	able 9: values added	d for lower voltage ranges.
74LVC_LVCH16245A v.10	20110623	Product data sheet	-	74LVC_LVCH16245A v.9
Modifications:	 type numbers and 74LVCH16 		LVCH16245ABQ cha	anged to 74LVC16245ABX
	 Figure 6: figure 	e note 1 changed.		
74LVC_LVCH16245A v.9	20100329	Product data sheet	-	74LVC_LVCH16245A v.8
74LVC_LVCH16245A v.8	20081106	Product data sheet	-	74LVC_LVCH16245A v.7
74LVC_LVCH16245A v.7	20031125	Product specification	-	74LVC_LVCH16245A v.6
74LVC_LVCH16245A v.6	20030130	Product specification	-	74LVC_LVCH16245A v.5
74LVC_LVCH16245A v.5	20021030	Product specification	-	74LVC_H16245A v.4
74LVC_H16245A v.4	19970925	Product specification	-	74LVC16245A_ 74LVCH16245A v.3
74LVC16245A_ 74LVCH16245A v.3	19970925	Product specification	-	74LVC16245A v.2
74LVC16245A v.2	19970801	Product specification	-	74LVC16245A v.1
74LVC16245A v.1	-		-	

15. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

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Product data sheet

74LVC16245A; 74LVCH16245A

NXP Semiconductors

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

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